

# FCA65S20D1Q

## eSiC Silicon Carbide Schottky Diode

650V, 20A



### Description

The 650V eSiC is an advanced Faster Semiconductor's silicon carbide diode family. This technology combines the benefits of excellent low capacitive charge and robustness. Consequently, the eSiC family is suitable for application requiring high power efficiency.

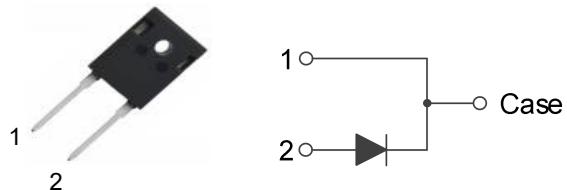
### Applications

- Power Factor Correction
- Industrial Power Supplies
- Solar Inverter, UPS

### Features

V <sub>RRM</sub>	I <sub>F</sub>	T <sub>J,max</sub>	Q <sub>c</sub>
650 V	20 A	175 °C	62 nC

- No reverse recovery current
- Low capacitive charge
- 175°C Max junction temperature
- High surge current capability
- Switching behavior independent of temperature
- Pb-Free, Halogen Free and RoHS compliant



### Absolute Maximum Ratings ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Value	Unit
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage		650	V
I <sub>F</sub>	Forward Current	$T_C=128^\circ\text{C}$	20	A
I <sub>F,SM</sub>	Non-Repetitive Forward Surge Current	$T_C=25^\circ\text{C}, t_p=10 \text{ ms}$	95	A
		$T_C=150^\circ\text{C}, t_p=10 \text{ ms}$	80.8	A
I <sub>F,Max</sub>	Non-Repetitive Peak Forward Current	$T_C=25^\circ\text{C}, t_p=10 \text{ us}$	880	A
		$T_C=150^\circ\text{C}, t_p=10 \text{ us}$	748	A
I <sup>2</sup> dt value	$\int I^2 dt$	$T_C=25^\circ\text{C}, t_p=10 \text{ ms}$	45.1	A <sup>2</sup> s
		$T_C=150^\circ\text{C}, t_p=10 \text{ ms}$	32.6	A <sup>2</sup> s
P <sub>tot</sub>	Power Dissipation	$T_C=25^\circ\text{C}$	121	W
T <sub>J</sub> , T <sub>STG</sub>	Operating Junction and Storage Temperature		-55 to +175	°C

### Thermal Characteristics

Symbol	Parameter	Value	Unit
R <sub>θJC</sub>	Thermal Resistance, Junction to Case, Max.	1.24	°C/W

## Package Marking and Ordering Information

Part Number	Top Marking	Package	Packing Method	Quantity
FCA65S20D1Q	FCA65S20D1Q	TO-247-2L	Tube	30 units

## Electrical Characteristics ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$V_F$	Forward Voltage	$I_F=20 \text{ A}, T_C=25^\circ\text{C}$		1.40	1.7	V
		$I_F=20 \text{ A}, T_C=175^\circ\text{C}$		1.55	-	
$I_R$	Reverse Current	$V_R=650 \text{ V}, T_C=25^\circ\text{C}$		-	100	$\mu\text{A}$
		$V_R=650 \text{ V}, T_C=175^\circ\text{C}$		-	300	
$Q_C$	Total Capacitive Charge	$V_R=400 \text{ V}, T_C=25^\circ\text{C}$		62		nC
$C$	Total Capacitance	$V_R=1 \text{ V}, f=100 \text{ kHz}$		1010		pF
		$V_R=400 \text{ V}, f=100 \text{ kHz}$		99		
$E_C$	Capacitance Stored Energy	$V_R=400 \text{ V}, T_C=25^\circ\text{C}$		9.2		$\mu\text{J}$

## Typical Performance Characteristics

Figure 1. Power Derating

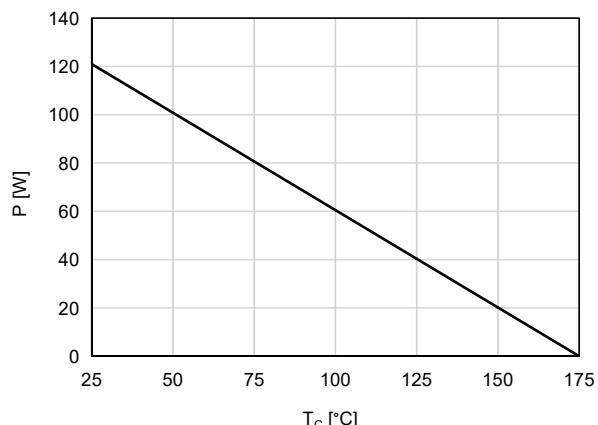


Figure 2. Current Derating

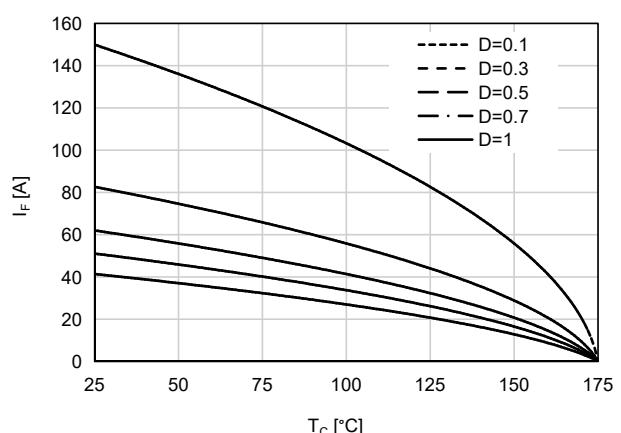


Figure 3. Forward Characteristics

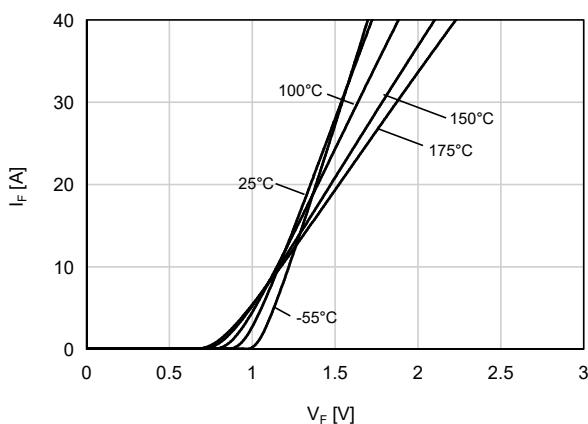


Figure 4. Reverse Characteristics

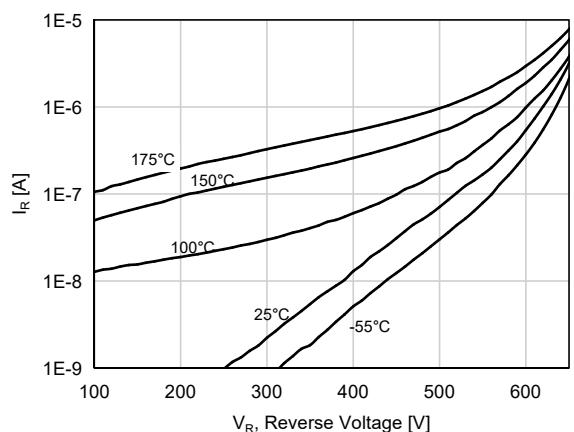


Figure 5. Capacitive Charge Characteristic

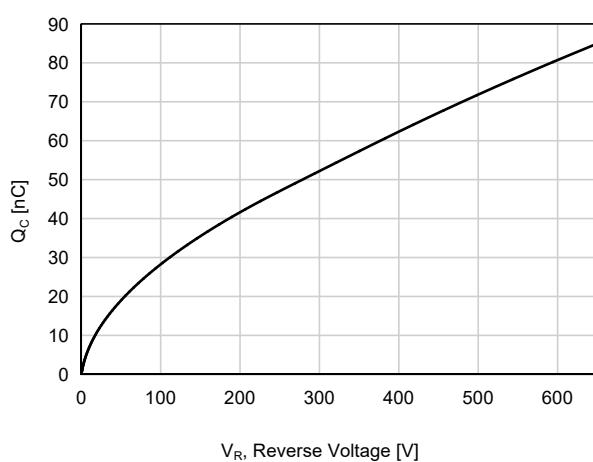
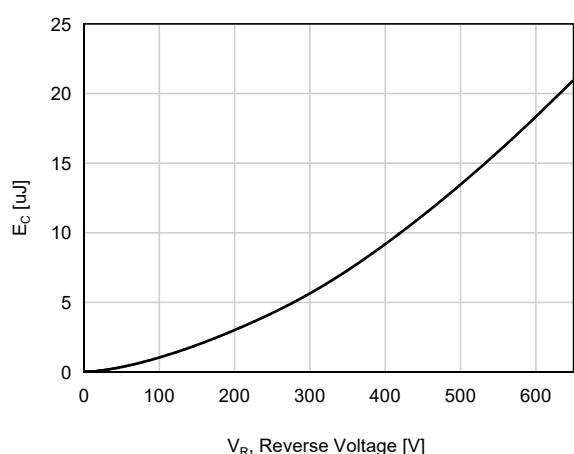
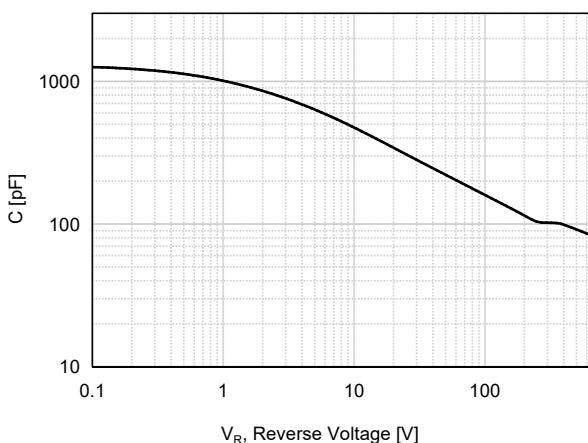
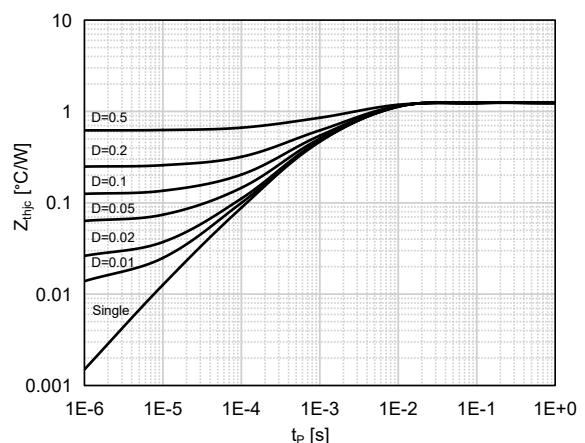


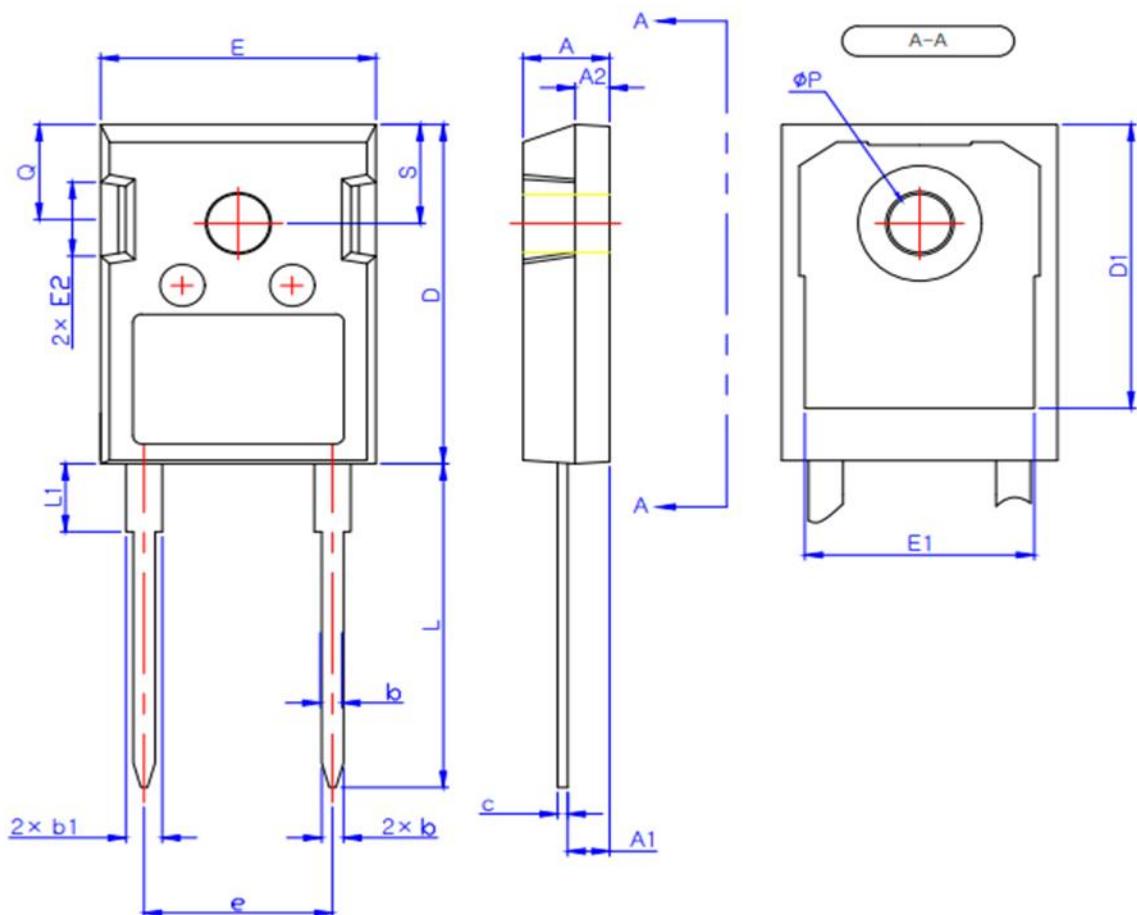
Figure 6. Capacitance Stored Energy



**Typical Performance Characteristics****Figure 7. Capacitance Characteristic****Figure 8. Transient Thermal Response Curve**

## Package Outlines

## TO-247-2L



SYMBOL	MIN	MAX
A	4.80	5.20
A1	2.29	2.54
A2	1.90	2.10
b	1.10	1.30
b1	1.91	2.20
c	0.50	0.70
D	20.80	21.34
D1	17.43	17.83
E	15.75	16.13
E1	13.06	13.46
E2	4.32	4.83
e	10.90 BSC	
L	19.85	20.25
L1	-	4.49
ØP	3.55	3.65
Q	5.59	6.19
S	6.15 BSC	

\* Dimensions in millimeters